



2823

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Tai-Peng Lee; Chuck Jang  
Assignee: Mosel Vitelic, Inc.  
Title: Reduced Thickness Variation In A Material Layer Deposited In Narrow and Wide Integrated Circuit Trenches  
Serial No.: 10/033,114 Filing Date: October 22, 2001  
Examiner: Garcia, Joanne A. Group Art Unit: 2823  
Docket No.: M-11912 US

San Jose, California  
February 26, 2004

COMMISSIONER FOR PATENTS  
P.O. BOX 1450  
ALEXANDRIA, VA 22313-1450

RESPONSE TO OFFICE COMMUNICATION

Dear Sir:

In response to the Office Communication having a mailing date of Feb. 13, 2004, please accept the below, latest, Claim Listing which is believed to be in compliance with 37 CFR §1.121. (As an aside, it is respectfully submitted that neither the rule nor the online help pages are models of clarity. They do not clearly define what a "Claim Listing" is. Applicant hopes the below finally complies. A telephone call is requested if not.)

RECEIVED  
MAR 08 2004